

ezyLED 24V AC 3030 EMC AB-EZP Series

ezyLED reduces driving circuit dramatically. All ezyLEDs are connected in parallel, and directly driven by a conventional 24V AC/DC voltage source without the needs of the driver IC and passive components. With ezyLED so easy to use, users only have to focus on the design of the lamps. Inventory management of components is minimized.



AB-EZP products operate over a wide voltage range (Figure 3). Luminous intensity remains constant for $22.5V < V_{in} < 36V$, and maintains approximately 50% of its nominal value when input voltage drops to 21.5 volts.

AB-EZP products support over temperature protection (OTP) by reducing input current and hence the luminous intensity when the device temperature exceeds $120^{\circ}C$ (Figure 2). For long-term reliability, sufficient heat dissipation mechanism in lamp design is required to ensure ezyLED operates in the rated temperature range ($-40^{\circ}C \sim 85^{\circ}C$).

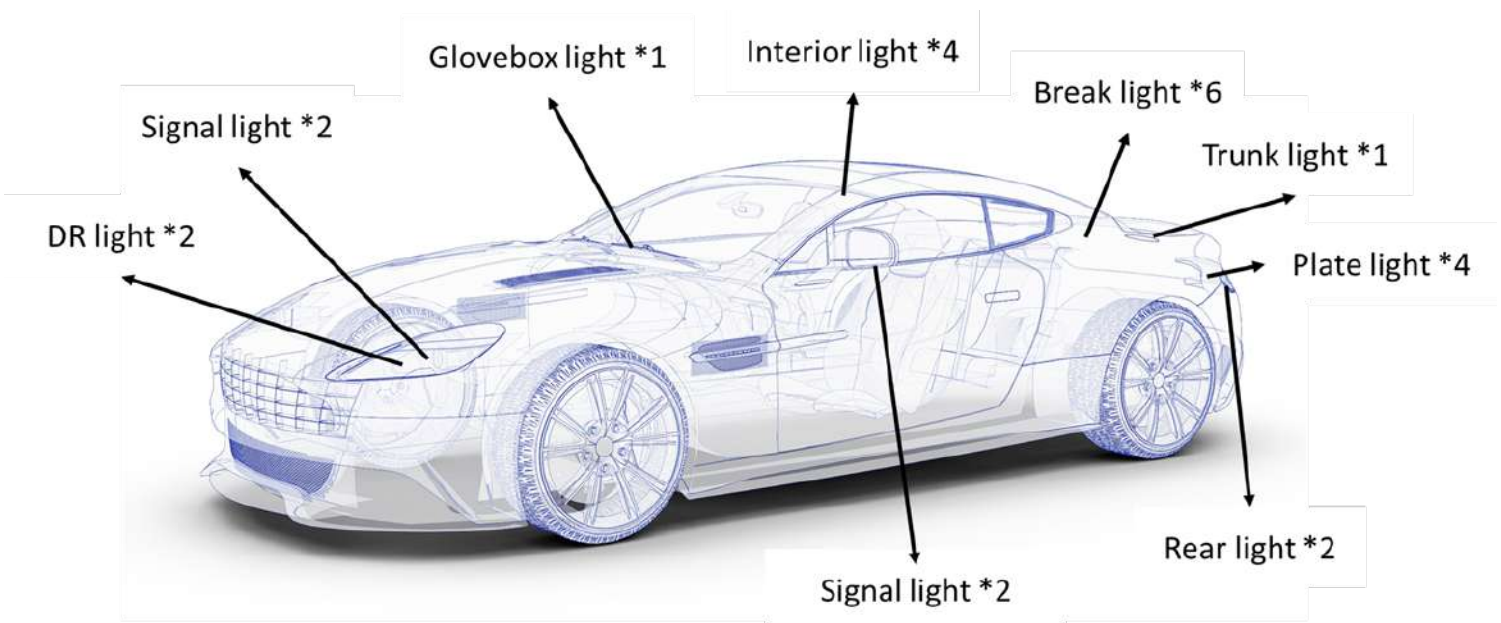


Features

- Patented LED chip design with built-in driving IC
- Using conventional 24V AC/DC voltage sources
- All ezyLEDs connected in parallel
- Luminance and Correlated color temperature (CCT) remain constant while the input voltage varies over an extensive range
- Built-in rectification for non-polar applications
- Over temperature protection

Application

- Automotive lighting
- Architectural lighting
- General lighting
- Down light
- Landscape lighting



General Characteristics (Ta=25°C @ Vin =12V)

Parameters	Symbol	Min.	Typ.	Max.	Unit
Luminous Flux@20mA (0.3W)	Φ_v		30		lm
Luminous Flux@50mA (0.5W)	Φ_v		60		lm
Luminous Flux@100mA (1.0W)	Φ_v		110		lm
Luminous Flux@110mA (Red)	Φ_v	39	42	44	lm
Luminous Flux@110mA (Green)	Φ_v	71	75	79	lm
Luminous Flux@110mA (Blue)	Φ_v	25	26	27	lm
Viewing Angle (FWHM)	$2\theta_{1/2}$		120		degree
Thermal Resistance (Junction to slug)	R_{th}		15		°C/W

Absolute Maximum Ratings

Parameters	Symbol	Min.	Typ.	Max.	Unit
Rated Voltage	Vin	22.5	24	36	Vdc
LED Junction Temperature	T _J			120	°C
Operation Temperature Range	T _c	-40		85	°C
ESD@HBM	ESDHBM			4K	V
Allowable Reflow cycles	-			3	cycles
Storage Temperature Range	-	-40		100	°C

Notes :

Parts are tested in pulsed conditions, T_a=25°C.

Pulse width is 10ms at rated voltage.

Tolerance of Luminous Intensity: ±10%

Maximum Temperature at solder pads (T_c) during operation: 85°C

The lifetime will be decreased if the operation temperature exceeds the maximum value.

Ordering Information

Color	CCT/Wavelength		CRI	Power	Light Output (Typ)		Part number
	Min	Max			Ta=25°C	Tc=85°C	
Red	620nm	630nm	NA	0.3	9 lm	7lm	AB-EZP03R-B3
Blue	445nm	465nm	NA	0.3	6 lm	5lm	AB-EZP03B-B3
Cool White	7000K	9000K	70	0.5	55 lm	45 lm	AB-EZP05C-B3-K80
Cool White	6000K	7000K	70	0.5	55 lm	45 lm	AB-EZP05C-B3-K65
Cool White	5400K	6000K	70	0.5	55 lm	45 lm	AB-EZP05C-B3-K57
Neutral White	3725K	4275K	70	0.5	55 lm	45 lm	AB-EZP05N-B3-K40
Warm White	2850K	3150K	80	0.5	55 lm	45 lm	AB-EZP05W-B3-K30
Warm White	2650K	2850K	80	0.5	55 lm	45 lm	AB-EZP05W-B3-K27
Amber	1800K		NA	0.5	35 lm	25 lm	AB-EZP05A-B3-K18
Amber	1300K		NA	0.5	35 lm	25 lm	AB-EZP05A-B3-K13
Red	620nm	630nm	NA	0.6	20 lm	16 lm	AB-EZP06R-B3
Blue	445nm	465nm	NA	0.6	12 lm	11 lm	AB-EZP06B-B3
Cool White	7000K	9000K	70	1	110 lm	90 lm	AB-EZP10C-B3-K80
Cool White	6000K	7000K	70	1	110 lm	90 lm	AB-EZP10C-B3-K65
Cool White	5400K	6000K	70	1	110 lm	90 lm	AB-EZP10C-B3-K57
Neutral White	3725K	4275K	70	1	110 lm	90 lm	AB-EZP10N-B3-K40
Warm White	2850K	3150K	80	1	110 lm	90 lm	AB-EZP10W-B3-K30
Warm White	2650K	2850K	80	1	110 lm	90 lm	AB-EZP10W-B3-K27
Amber	1800K		NA	1	65 lm	50 lm	AB-EZP10A-B3-K18
Amber	1300K		NA	1	65 lm	50 lm	AB-EZP10A-B3-K13
Red	620nm	630nm	NA	1.3	39 lm	32 lm	AB-EZP13R-B3
Blue	445nm	465nm	NA	1.3	25 lm	22 lm	AB-EZP13B-B3
Cool White	7000K	9000K	70	2.4	210 lm	170 lm	AB-EZP24C-B3-K80
Cool White	6000K	7000K	70	2.4	210 lm	170 lm	AB-EZP24C-B3-K65
Cool White	5400K	6000K	70	2.4	210 lm	170 lm	AB-EZP24C-B3-K57
Neutral White	3725K	4275K	70	2.4	210 lm	170 lm	AB-EZP24N-B3-K40
Warm White	2850K	3150K	80	2.4	210 lm	170 lm	AB-EZP24W-B3-K30
Warm White	2650K	2850K	80	2.4	210 lm	170 lm	AB-EZP24W-B3-K27
Red	620nm	630nm	NA	2.4	72 lm	60 lm	AB-EZP24R-B3
Blue	445nm	465nm	NA	2.4	46 lm	41 lm	AB-EZP24B-B3

Notes:

Maintains a tolerance of +/-10% on flux measurements and +/-2 on CRI measurements.
Parts are tested in pulsed conditions, Ta=25°C. Pulse width is 10ms at rated test voltage.

Figure 1. Relative Spectral Power Distribution ($V_f=24Vdc$)

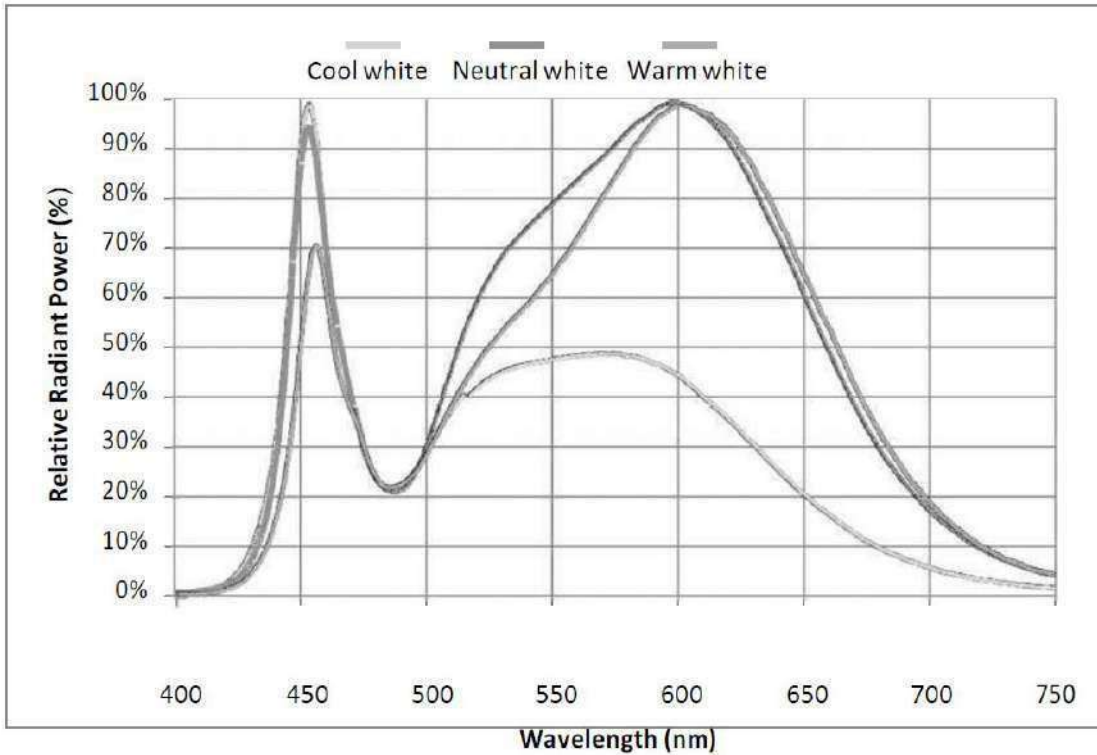


Figure 2 Relative Luminous Flux vs. Temperature (T_c)

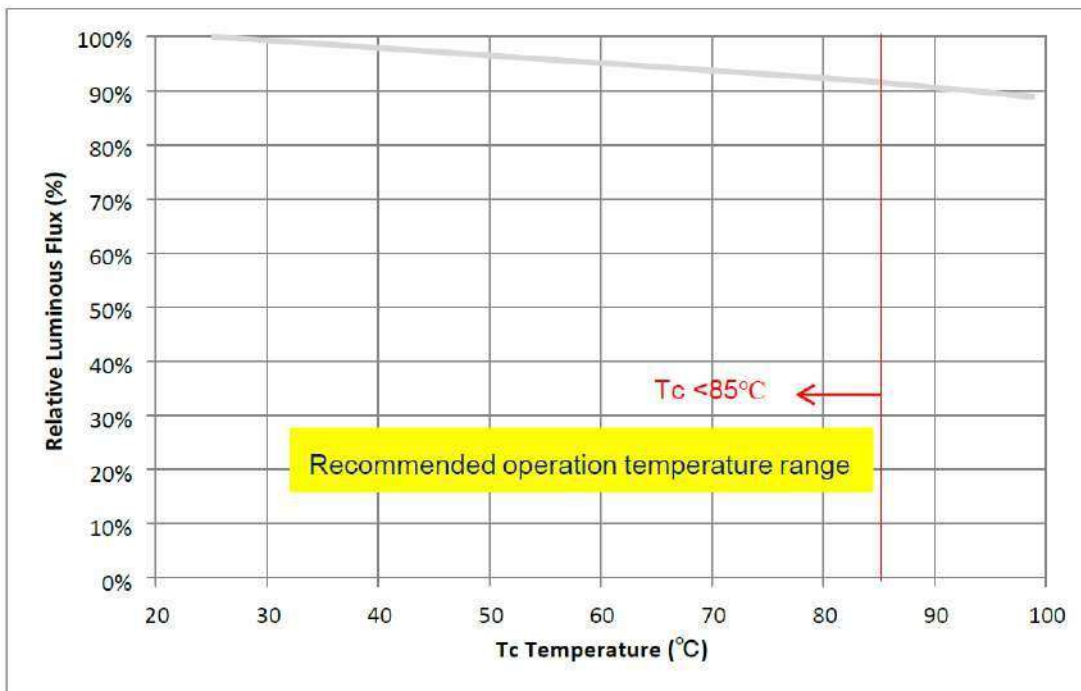


Figure 3 Relative Luminous Flux vs. Operation Voltage (Tc<85°C)

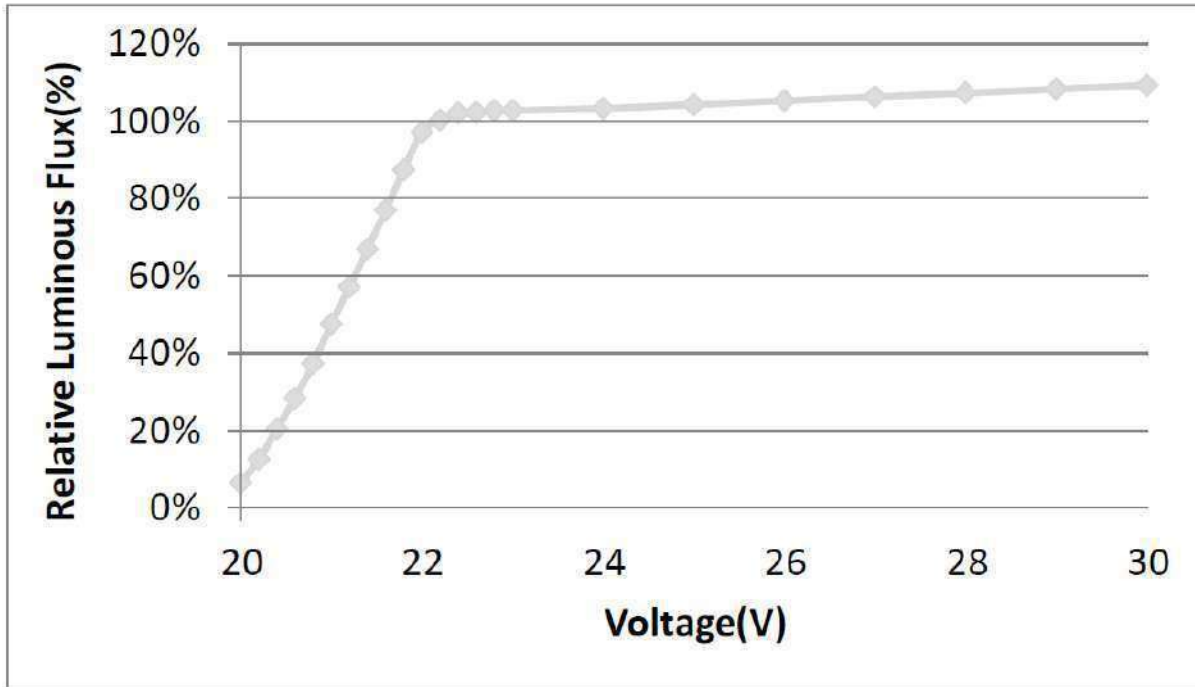


Figure 4 Radiation Diagram

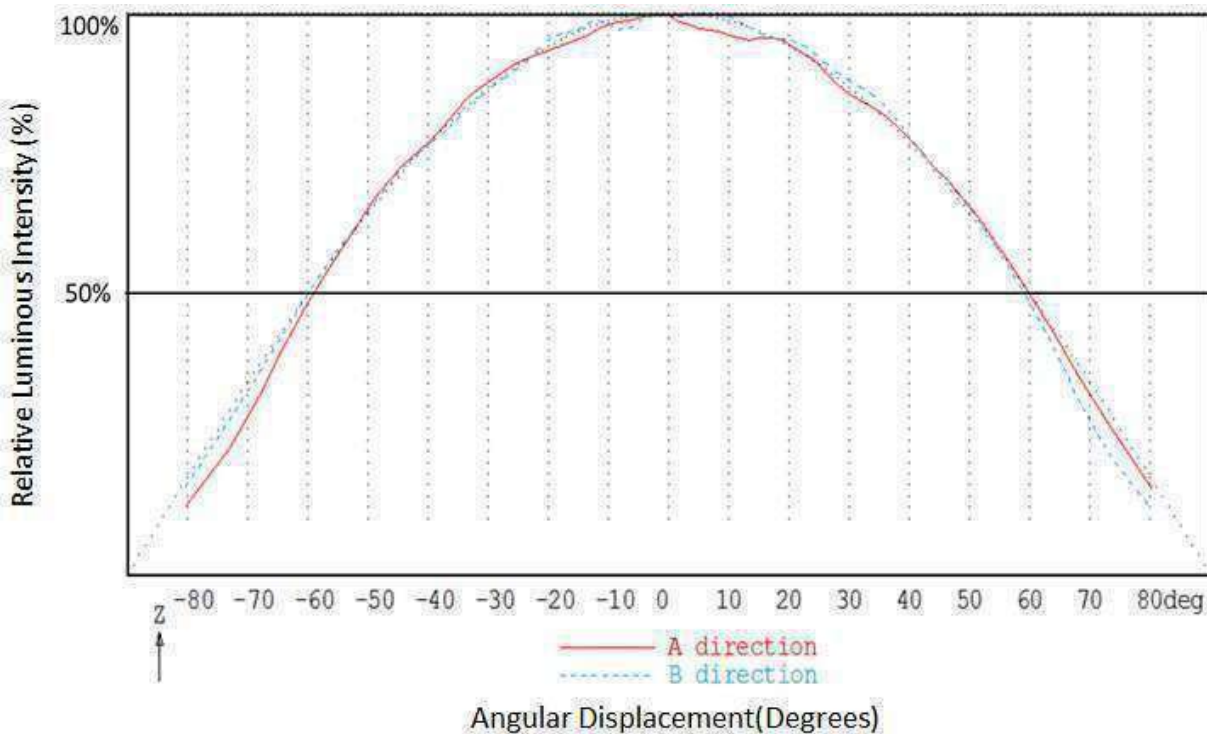


Figure 5 ezyLED ANSI White Bins Plotted on the 1931 CIE Color Space ($T_j=85^\circ\text{C}$)

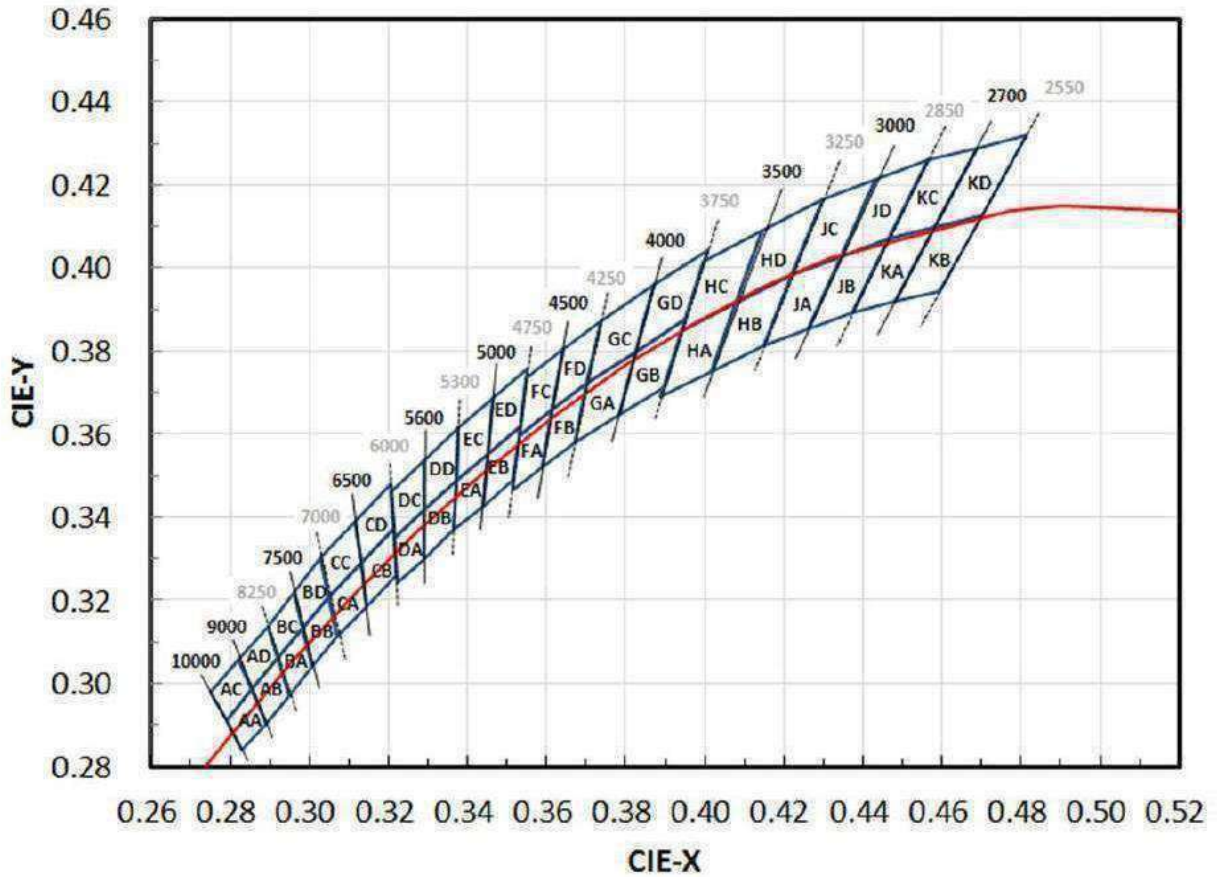
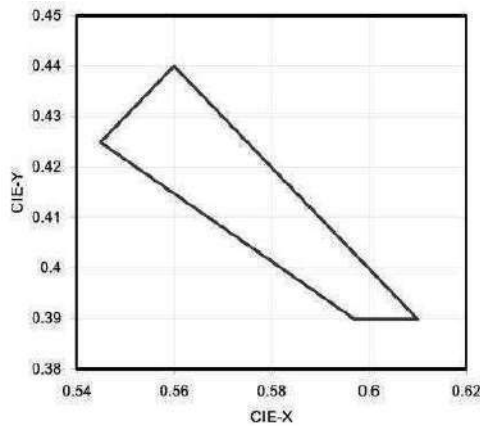


Figure 6 ezyLED PC-amber Plotted on the 1931 CIE Color Space ($T_j=85^\circ\text{C}$)



ezyLED are tested for chromaticity and placed into one of the regions defined by the following bounding coordinates

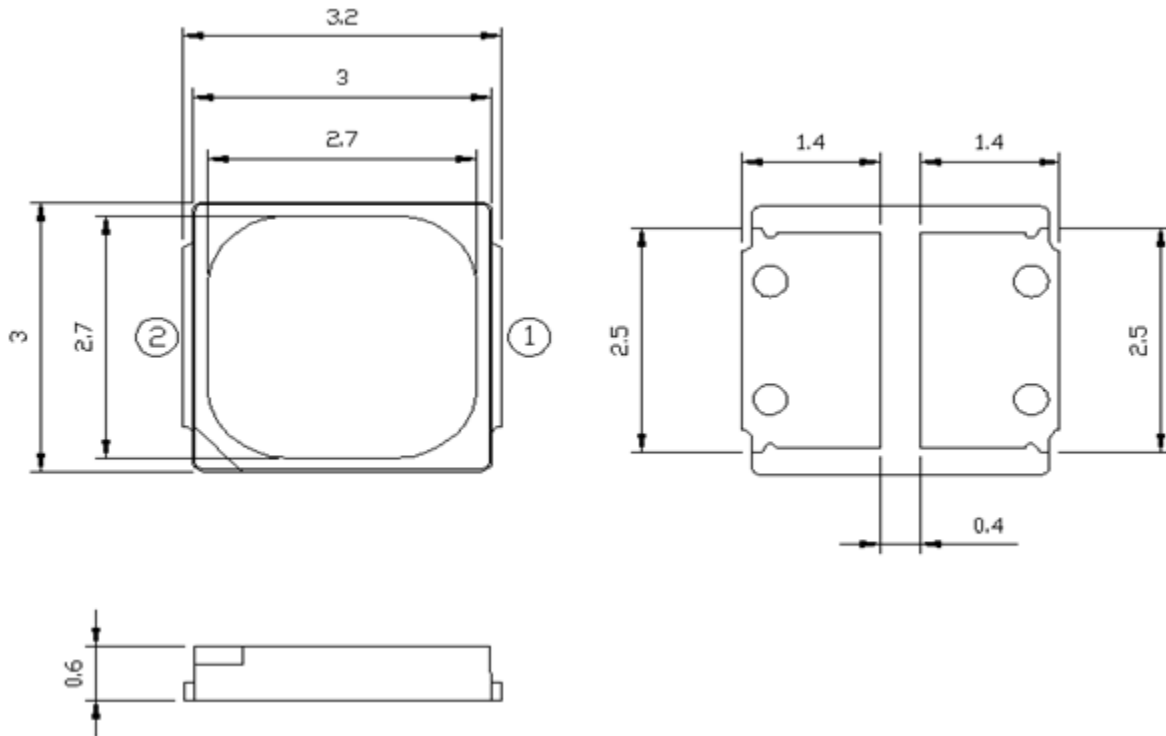
- White light product:

AA	0.2830	0.2840	BA	0.2950	0.2970	CA	0.3068	0.3113	DA	0.3222	0.3243	EA	0.3366	0.3369
	0.2790	0.2910		0.2920	0.3060		0.3048	0.3207		0.3215	0.3350		0.3371	0.3490
	0.2855	0.2985		0.2984	0.3133		0.3130	0.3290		0.3290	0.3417		0.3451	0.3554
	0.2890	0.2905		0.3009	0.3042		0.3144	0.3186		0.3290	0.3300		0.3440	0.3427
AB	0.2830	0.2840	BB	0.2950	0.2970	CB	0.3068	0.3113	DB	0.3222	0.3243	EB	0.3366	0.3369
	0.2890	0.2905		0.3009	0.3042		0.3144	0.3186		0.3290	0.3300		0.3440	0.3427
	0.2855	0.2985		0.2984	0.3133		0.3130	0.3290		0.3290	0.3417		0.3451	0.3554
	0.2920	0.3060		0.3048	0.3207		0.3213	0.3373		0.3371	0.3490		0.3533	0.3620
AC	0.2790	0.2910	BC	0.2920	0.3060	CC	0.3048	0.3207	DC	0.3215	0.3350	EC	0.3371	0.3490
	0.2750	0.2980		0.2895	0.3135		0.3028	0.3304		0.3207	0.3462		0.3376	0.3616
	0.2823	0.3058		0.2962	0.3220		0.3115	0.3391		0.3290	0.3538		0.3463	0.3687
	0.2855	0.2985		0.2984	0.3133		0.3130	0.3290		0.3290	0.3417		0.3451	0.3554
AD	0.2790	0.2910	BD	0.2920	0.3060	CD	0.3048	0.3207	DD	0.3215	0.3350	ED	0.3371	0.3490
	0.2855	0.2985		0.2984	0.3133		0.3130	0.3290		0.3290	0.3417		0.3451	0.3554
	0.2823	0.3058		0.2962	0.3220		0.3115	0.3391		0.3290	0.3538		0.3463	0.3687
	0.2895	0.3135		0.3028	0.3304		0.3205	0.3481		0.3376	0.3616		0.3551	0.3760
FA	0.3512	0.3465	GA	0.3670	0.3578	HA	0.3889	0.3690	IA	0.4147	0.3814	KA	0.4373	0.3893
	0.3530	0.3597		0.3702	0.3722		0.3941	0.3848		0.4221	0.3984		0.4465	0.4071
	0.3615	0.3659		0.3825	0.3798		0.4080	0.3916		0.4342	0.4028		0.4582	0.4099
	0.3590	0.3521		0.3783	0.3646		0.4017	0.3751		0.4259	0.3853		0.4483	0.3919
FB	0.3512	0.3465	GB	0.3670	0.3578	HB	0.3889	0.3690	JB	0.4147	0.3814	KB	0.4373	0.3893
	0.3590	0.3521		0.3783	0.3646		0.4017	0.3751		0.4259	0.3853		0.4483	0.3919
	0.3615	0.3659		0.3825	0.3798		0.4080	0.3916		0.4342	0.4028		0.4582	0.4099
	0.3702	0.3722		0.3950	0.3875		0.4221	0.3984		0.4465	0.4071		0.4700	0.4125
FC	0.3670	0.3578	GC	0.3898	0.3716	HC	0.4147	0.3814	JC	0.4373	0.3893	KC	0.4593	0.3944
	0.3590	0.3521		0.3783	0.3646		0.4017	0.3751		0.4259	0.3853		0.4483	0.3919
	0.3530	0.3597		0.3702	0.3722		0.3941	0.3848		0.4221	0.3984		0.4465	0.4071
	0.3641	0.3804		0.3869	0.3958		0.4146	0.4089		0.4430	0.4212		0.4687	0.4289
FD	0.3615	0.3659	GD	0.3825	0.3798	HD	0.4080	0.3916	JD	0.4342	0.4028	KD	0.4582	0.4099
	0.3530	0.3597		0.3702	0.3722		0.3941	0.3848		0.4221	0.3984		0.4465	0.4071
	0.3641	0.3804		0.3869	0.3958		0.4146	0.4089		0.4430	0.4212		0.4687	0.4289
	0.3736	0.3874		0.4006	0.4044		0.4299	0.4165		0.4562	0.4260		0.4813	0.4319
FA	0.3702	0.3722	GA	0.3950	0.3875	HA	0.4221	0.3984	IA	0.4465	0.4071	KA	0.4700	0.4125
	0.3615	0.3659		0.3825	0.3798		0.4080	0.3916		0.4342	0.4028		0.4582	0.4099
	0.3590	0.3521		0.3783	0.3646		0.4017	0.3751		0.4259	0.3853		0.4483	0.3919
	0.3512	0.3465		0.3670	0.3578		0.3889	0.3690		0.4147	0.3814		0.4373	0.3893

- PC-amber product:

PC-amber	0.56	0.44
	0.54491	0.42491
	0.59701	0.39
	0.61	0.39

Figure 7 Mechanical Dimensions



Notes:

1. All dimensions are in mm.
2. Tolerance is +/- 0.1mm unless otherwise specified.
3. Drawings are not to scale.

Figure 8 Block diagram

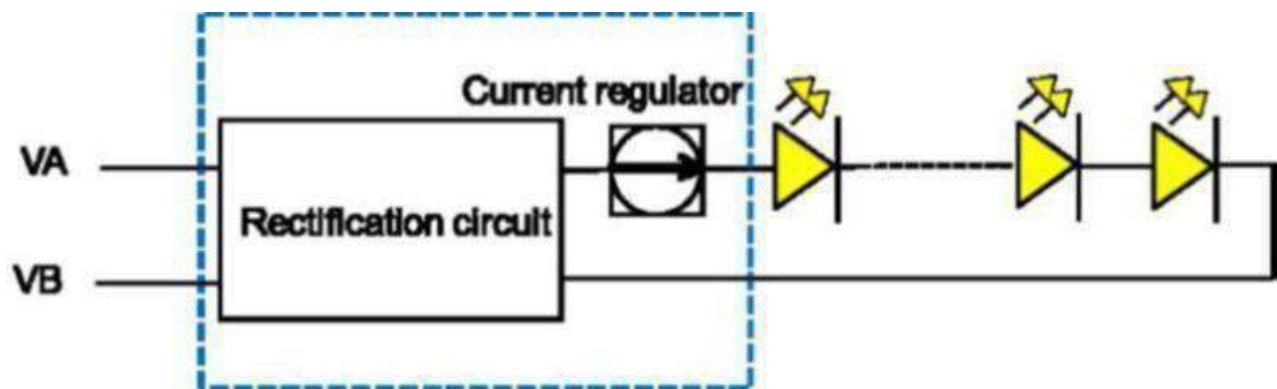
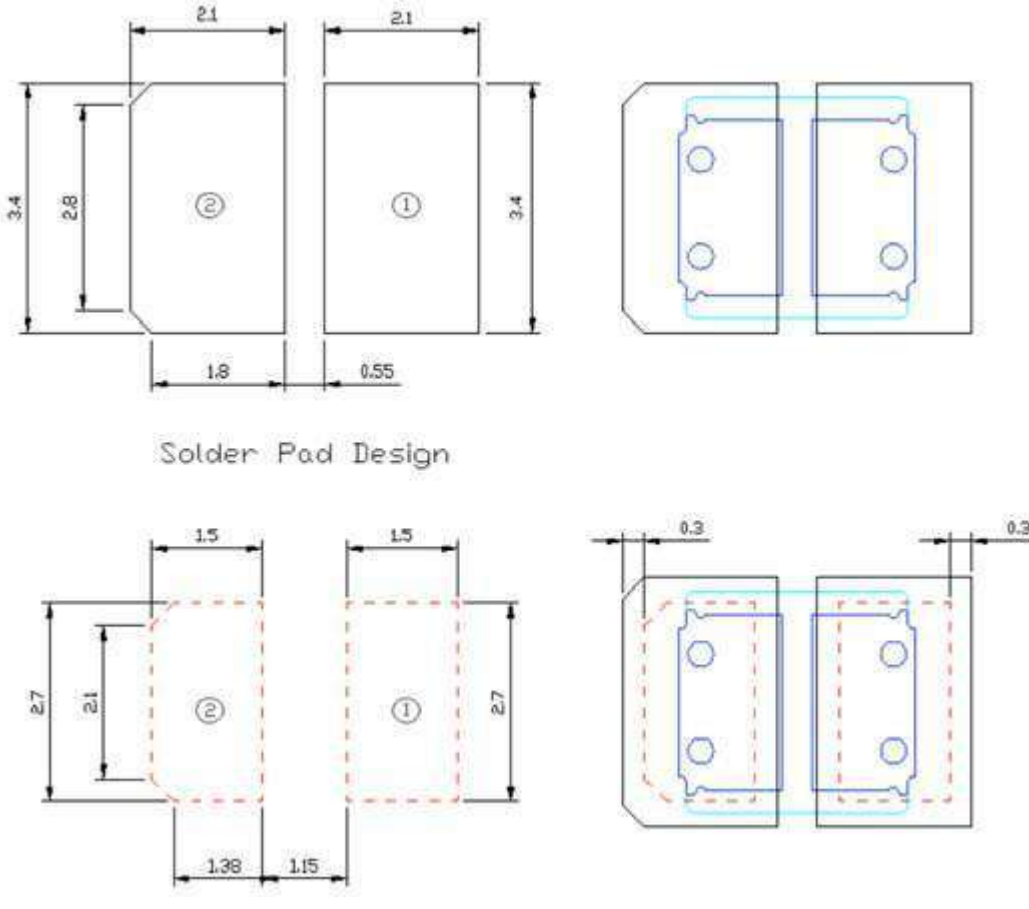


Figure 9 Recommended Solder Pad Dimensions



Solder Pad Design

Pad	Function
1	VA
2	VB

Notes:

1. All dimensions are in mm.
2. Tolerance is +/- 0.02mm unless otherwise specified.
3. Drawings are not to scale.
4. The other pads on 3030 devices are NC isolated with pad 1&2. (No solder paste)
5. Do not handle 3030 devices by the lens. Incorrect force applied to the lens may lead to the failure .
6. This solder pad dimension could be applied to both lead-frame types of ezyLED.

Figure 10 Application reference

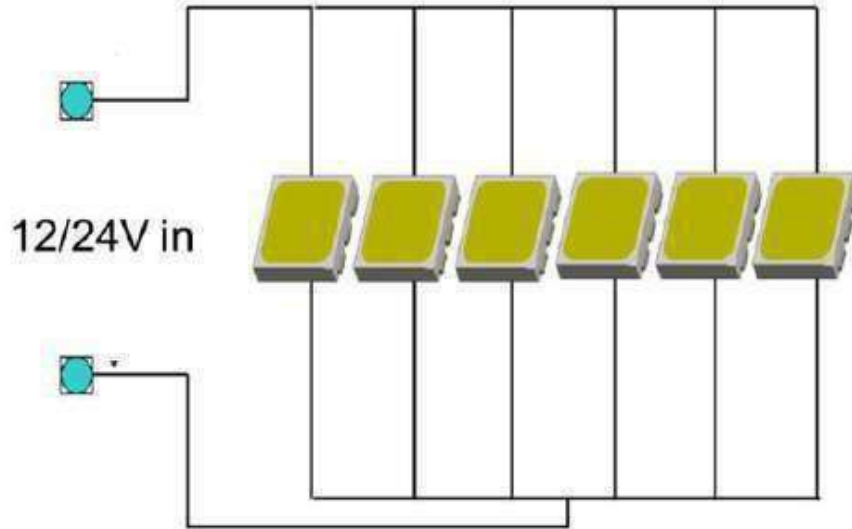


Figure 11 EMC Package

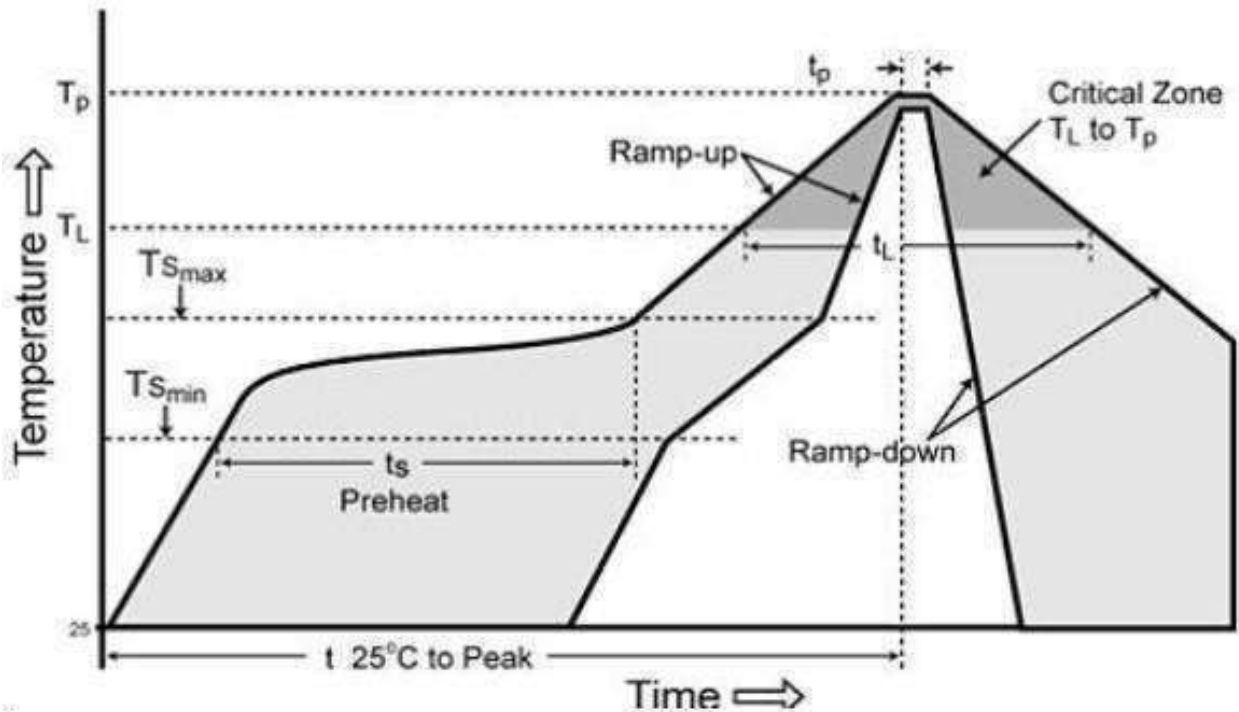
The figure shows a cross-section of an LED package and its final appearance. The cross-section labels include: LED chip, Wire, White epoxy molding compound, Transparent compound, Metal PCB, and Lead frame. The 'Product appearance' shows three cylindrical white packages. Below this, 'After Transfer Molding' shows a tray of packaged LEDs, and 'A Lighting Blue LED' shows a single package emitting a blue glow with a 5mm scale bar.

CEL-W-Series(7005D1 etc.)

- Long-lasting high reflection
- Good heat and UV resistance
- Applicable for transfer molding including MAP

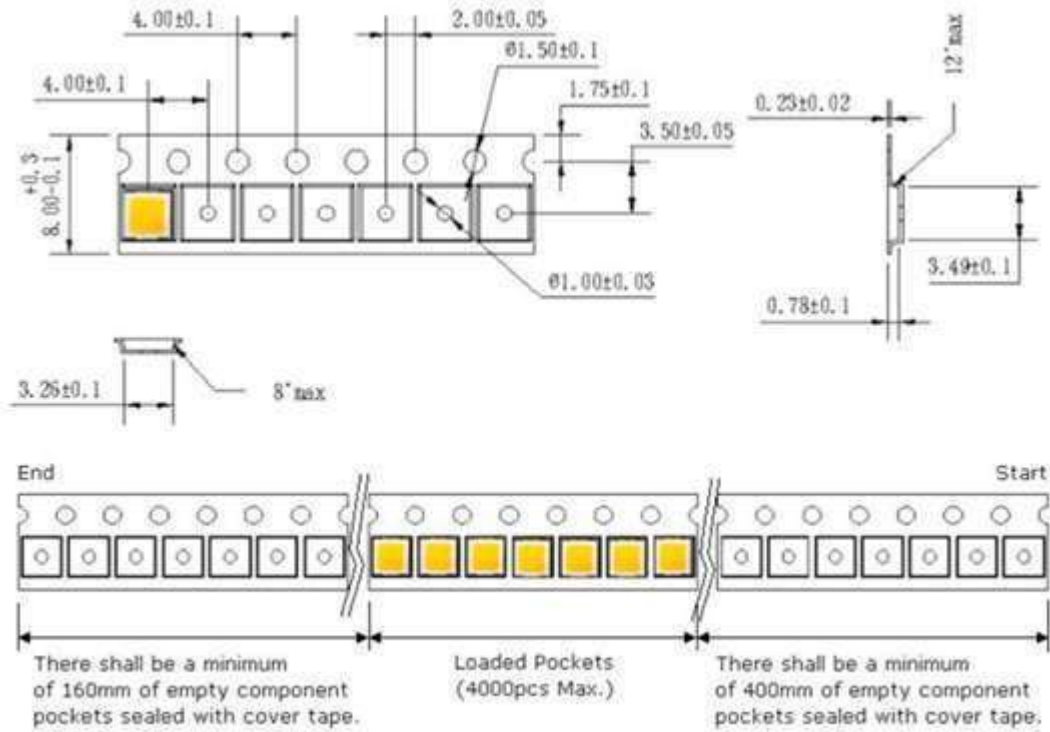
Figure 12 Soldering Condition (Reference: IPC/JEDEC J-STD-020C)

ezyLED ZE1C series are compatible with IPC/JEDEC J-STD-020C, following the parameters listed below. Recommends that users follow the recommended soldering profile as the general guideline.



Profile Feature	Pb-Free Assembly
Average ramp-up rate (TL to TP)	3°C/second max.
Preheat	
Temperature Min (Tsmmin)	150°C
Temperature Max (Tsmmax)	200°C
Time (min to max) (ts)	60-180 seconds
Time maintained above:	
Temperature (TL)	217°C
Time (tL)	60-150 seconds
Peak/Classification Temperature (Tp)	240°C
Time within 5°C of actual Peak Temperature (tp)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

Figure 13 Tape and Reel Package



Notes:

Dimensions are in millimeters
Tolerance: $\pm 0.2\text{mm}$
4000 pcs/ reel